	Type	L #	Hits	Search T xt	DBs	Time Stamp
1	BRS	L1	733	"solder ball" with (bond$3 near2 pad$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 08:47
2	BRS	L154	14	1 and customiz$8	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 08:48
3	BRS	L155	3860	(screen near2 print$4) near8 (epoxy or solder)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 08:53
4	BRS	L156	39	155 and customiz$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 08:50
5	BRS	L157	2778	(screen near2 print$4) near4 (epoxy or solder)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 08:54

	Typ	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L158	127	157 same (electrical$4 near2 connect$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 08:55

	Type	L #	Hits	Search Text	DBs
1	IS&R	L160	833	(438/612).CCLS.	USPAT; US-PGP UB
2	IS&R	L162	795	(438/613).CCLS.	USPAT; US-PGP UB
3	IS&R	L163	230	(438/617).CCLS.	USPAT; US-PGP UB
4	IS&R	L164	312	(438/128).CCLS.	USPAT; US-PGP UB
5	IS&R	L165	207	(438/129).CCLS.	USPAT; US-PGP UB
6	IS&R	L166	114	(438/130).CCLS.	USPAT; US-PGP UB
7	IS&R	L167	154	(438/131).CCLS.	USPAT; US-PGP UB
8	IS&R	L168	220	(438/132).CCLS..	USPAT; US-PGP UB
9	IS&R	L169	217	(438/598).CCLS.	USPAT; US-PGP UB
10	IS&R	L170	145	(438/599).CCLS.	USPAT; US-PGP UB
11	IS&R	L171	209	(438/600).CCLS.	USPAT; US-PGP UB
12	IS&R	L172	216	(438/601).CCLS.	USPAT; US-PGP UB

	Type	L #	Hits	Search T xt	DBs	Time Stamp
1	IS&R	L1	257	(438/119).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 17:33
2	IS&R	L8	1626	(438/128).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 18:02

	Type	L #	Hits	Search Text	DBs
4	BRS	L4	6	1 near8 (connect$4) near8 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB
5	BRS	L5	0	1 near8 (interconnect$4) near8 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB
6	BRS	L6	460	pad near2 adjacent$4 near4 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB

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Typ	L#	Hits	Search Text	DBs
7 BRS	L7	292	pad near2 adjacent$4 near2 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB
8 BRS	L8	59	pad near adjacent$4 near solder$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB
9 BRS	L9	2	1 near4 bridg$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB

07/14/2003, EAST Version: 1.03.0002

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	411	(first near2 second! near2 third) near2 pad	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB
2	BRS	L2	7	1 near4 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB
3	BRS	L3	1	1 near8 (between or among) near8 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB

Typ	L #	Hits	Search T xt	DBs
10 BRS	L10	2881	pad near4 bridg$4	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B
11 BRS	L11	264	pads! near4 bridg$4 near4 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B
12 BRS	L13	5	pads! near bridg$4 near solder$4	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B

Typ	L #	Hits	Search T xt	DBs
13 BRS	L12	63	pads! near2 bridg$4 near2 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB
14 BRS	L14	58	12 not 13	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB
15 BRS	L15	0	1 near4 fillet$4	USPAT; US-PG PUB; EPO; JPO; DERWENT; IBM_TDB

Typ	L #	Hits	S arch T xt	DBs
16 BRS	L16	2	1 near4 short$4	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B
17 BRS	L17	34	pads! near2 short$4 near2 solder$4	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B
18 BRS	L18	8	pads! near short$4 near solder$4	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B

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Typ	L #	Hits	S arch T xt	DBs
19 BRS	L19	26	17 not 18	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B
20 BRS	L20	0	1 near8 (fuse or antifuse)	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B
21 BRS	L21	2	1 same (fuse or antifuse)	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B

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Typ	L #	Hits	S arch Text	DBs
22 BRS	L22	791	pads! near8 (fuse or antifuse)	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B
23 BRS	L23	135	pads! near (fuse or antifuse)	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM_TD B